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U.S. DEPARTMENT OF COMMERCE  
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To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies):  
Yu-Li Su (1/16/2007) and Chun-Yu Lai (1/16/2007)

Additional name(s) of conveying party(ies) attached?  Yes  No

2. Name and address of receiving party(ies)  
Name: INVENTEC CORPORATION

Internal Address: \_\_\_\_\_

Street Address: \_\_\_\_\_

No. 66, Hou-Kang Street, Shih-Lin Dist,

City: Taipei,

State: \_\_\_\_\_

Country: Taiwan ROC Zip: \_\_\_\_\_

Additional name(s) & address(es) attached?  Yes  No

3. Nature of conveyance/Execution Date(s):

Execution Date(s): in parentheses after inventor name

Assignment  Merger  Change of Name

Security Agreement  Joint Research Agreement

Government Interest Assignment

Executive Order 9424, Confirmatory License

Other \_\_\_\_\_

4. Application or patent number(s):

This document is being filed together with a new application.

A. Patent Application No.(s)

This application

B. Patent No.(s)

Additional numbers attached?  Yes  No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Steven M. Rabin  
RABIN & BERDO, PC

Internal Address: Atty. Dkt.: TAIW-724

Street Address: 1101 14th St., NW  
Suite 500

City: Washington

State: DC Zip: 20005

Phone Number: (202) 371-8976

Fax Number: (202) 408-0924

Email Address: fjm@rabinberdo.com

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

Authorized to be charged by credit card

Authorized to be charged to deposit account

Enclosed

None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers \_\_\_\_\_

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Authorized User Name \_\_\_\_\_

9. Signature:

Signature

January 29, 2007

Date

Steven M. Rabin - 29,102

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

2

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(40.00 DP)

PATENT  
REEL: 018859 FRAME: 0577

**ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT**WHEREAS (1) Yu-Li SU (2) Chu-Yu LAI

hereinafter referred to collectively as the assignor, has invented a certain improvement relating to

**CALIBRATION METHOD OF INSULATING WASHER IN CIRCUIT BOARD**

[x] the inventor(s) declaration for said application being executed concurrently with the execution of this instrument; said application to be filed in the United States Patent and Trademark Office;

[ ] said application having been filed in the United States Patent and Trademark Office on \_\_\_\_\_, authorization being hereby given to my attorneys, Steven M. Rabin, Robert H. Berdo, Jr., Phillip G. Avruch and Allen Wood of RABIN & BERDO, P.C., 1101 14<sup>th</sup> Street, N.W., Suite 500, Washington, D.C. 20005, to insert here in parentheses (Application Serial No. \_\_\_\_\_) the application serial number of said application when known;

[ ] said application having been filed under the Patent Cooperation Treaty on \_\_\_\_\_, (Serial No. \_\_\_\_\_) the United States of America being designated.

AND WHEREAS INVENTEC CORPORATIONwho's address is No. 66, Hou-Kang Street, Shih-Lin Dist., Taipei, Taiwan, R.O.C.

hereinafter referred to as the assignee, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

<u>Yu-Li SU</u>	<u>Yu-Li Su</u>	<u>January 16, 2007</u>
Name of sole or first inventor	Signature	Date

<u>Chu-Yu LAI</u>	<u>Chu-Yu-LAI</u>	<u>January 16, 2007</u>
Name of second inventor, if any	Signature	Date

_____ Name of third inventor, if any	_____ Signature	_____ Date
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_____ Name of third inventor, if any	_____ Signature	_____ Date
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